# Hybrid 8j97 Traveler

December 7, 1999

## 1 Connectivity

Repairs on shorts:

Fixes for opens:

## 2 Chips

The following chips were assembled on this hybrid (in the order that the chips get read out):
Hybrid 8J97 has die: 000-000 000-000 000-000 000-000 000-000 000-000 000-000 000-000

## 3 Data Analysis Summary

The following summarizes the findings of the Burn-in data analysis program. The first chip in the readout name is numbered 0.

```
% Hybrid 8j97 classification info. Created 16:57:53 12/01/99

Hybrid 8j97 quality: fair
Chip classification: good fair good good good fair fair fair
Bad channels (chip-channel): 1-29 1-30 5-77 7-10
Bad cells: none
Random bad capacitors (chip-cell-channel): 6-35-117
Channels at pedestal needed for DCMS: 35.6 33.7 33.8 32.7 32.6 32.6 32.6 33.2
```

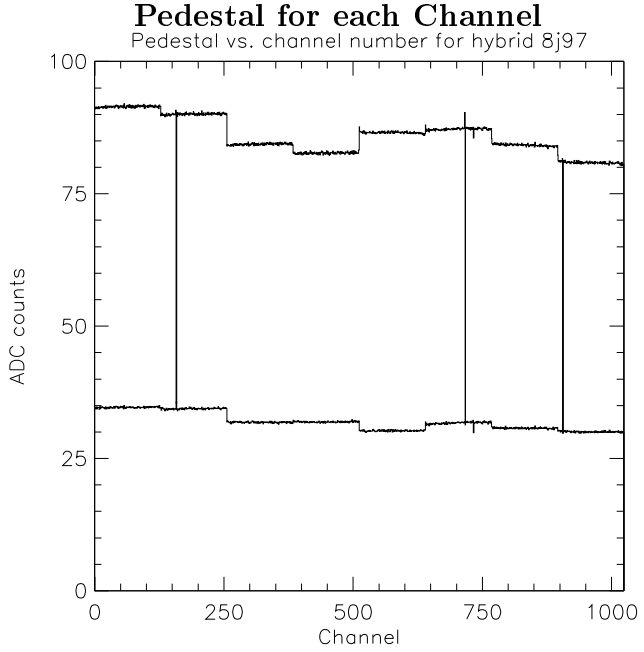
## 4 Comments

No comments.

# 5 Pedestal

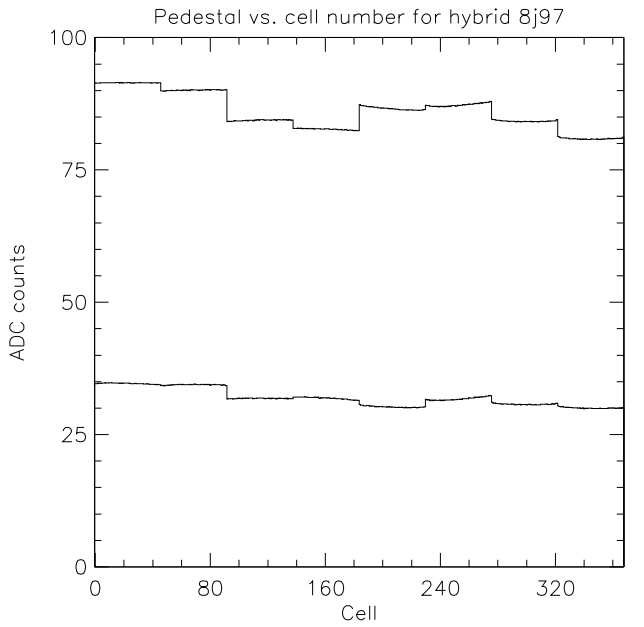
The following plot shows the pedestals vs. channel number with and without charge injection:

**Pedestal for each Channel**




The following plot shows the average pedestal vs. pipeline cell ID with and without charge injection. The x-axis is cell ID offset by 46 for each chip. Thus cell ID 5 for chip 1 is at x=5, chip 2 at x=51, chip 3 at x=97, etc.

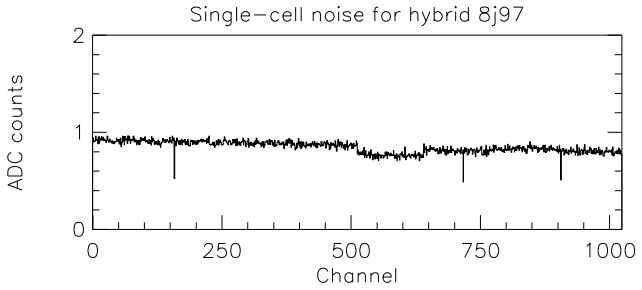
**Pedestal vs. Pipeline Cell ID**

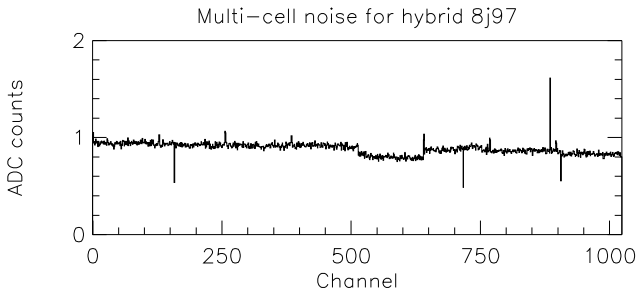


# 6 Noise

The following plots show the single-cell and multi-cell RMS noise:

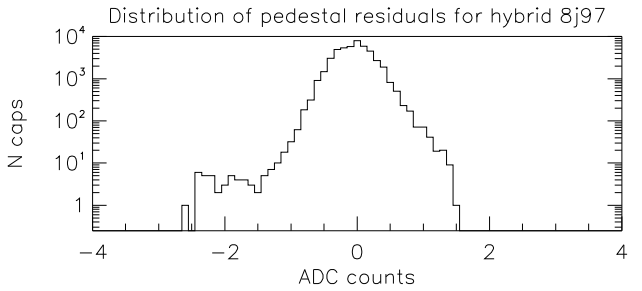
**RMS Noise**

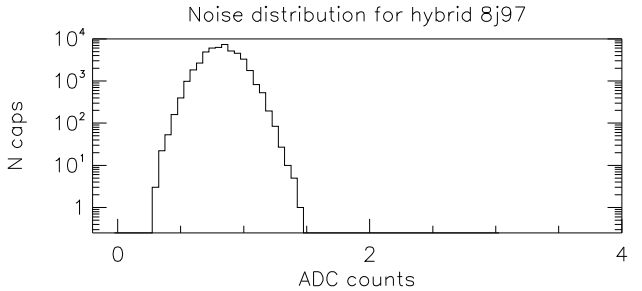


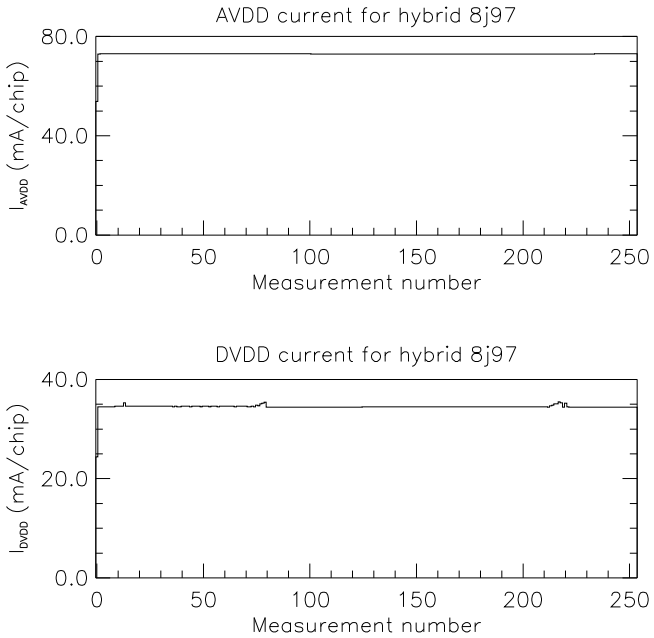

The following are histograms of the pedestal of each pipeline capacitor relative to the chip average (top); and the RMS noise of each capacitor (bottom):

**Distribution of Pedestals and Noise**



# 7 Currents

The following plots show the supply currents per chip as a function of measurment number. Currents are measured approximately every 10 minutes:

**Supply Currents During Burn-in**